

Weidmüller Interface GmbH & Co. KG Klingenbergstraße 26

D-32758 Detmold Germany

www.weidmueller.com

Product image





High-temperature-resistant male header, 3.50 mm pitch.

- Plugging direction parallel (90°), straight 180° or angled (135°) to PCB
- Housing variants: closed side (G), screw flange (F), solder flange (LF) or snap-on solder flange (RF)
- Optimised for the SMT process
- Pin length 3.2 mm universal for all soldering methods
- Pin length 1.5 mm optimised for reflow soldering methods
- Packed either in a box (BX) or tape-on-reel (RL)
- Male header can be coded

General ordering data

Version	PCB plug-in connector, male header, closed side,		
	THT/THR solder connection, 3.50 mm, Number		
	of poles: 24, 90°, Solder pin length (I): 3.2 mm,		
	tinned, black, Box		
Order No.	<u>1841850000</u>		
Туре	SL-SMT 3.50/24/90G 3.2SN BK BX		
GTIN (EAN)	4032248353200		
Qty.	20 pc(s).		
Product data	IEC: 320 V / 15 A		
	UL: 300 V / 10 A		
Packaging	Box		



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Technical data

Depth	11.1 mm	Depth (inches)	0.437 inch
Height	10.7 mm	Height (inches)	0.421 inch
Height of lowest version	7.5 mm	Width	85.4 mm
Width (inches)	3.362 inch	Net weight	6.2 g

System specifications

Product family	OMNIMATE Signal - series	Type of connection	
	BL/SL 3.50		Board connection
Mounting onto the PCB	THT/THR solder	Pitch in mm (P)	
	connection		3.5 mm
Pitch in inches (P)	0.138 inch	Outgoing elbow	90°
Number of poles	24	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin length tolerance	0 / -0.3 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder pin dimensions = d tolerance	0 / -0,03 mm
Solder eyelet hole diameter (D)	1.4 mm	Solder eyelet hole diameter tolerance (D)+ 0,1 mm	
Outside diameter of solder pad	2.3 mm	Template aperture diameter	2.1 mm
L1 in mm	80.5 mm	L1 in inches	3.169 inch
Number of rows	1	Pin series quantity	1
Touch-safe protection acc. to DIN VDE	Safe from back-of-hand	Touch-safe protection acc. to DIN VDE	
57 106	touch	0470	IP 10
Volume resistance	≤5 mΩ	Can be coded	Yes
Plugging force/pole, max.	6 N	Pulling force/pole, max.	6 N

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	Illa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	CuSn
Contact surface	tinned	Layer structure of plug contact	23 μm Ni / 57 μm Sn
Storage temperature, min.	-40 °C	Storage temperature, max.	70 °C
Operating temperature, min.	-50 °C	Operating temperature, max.	100 °C
Temperature range, installation, min.	-30 °C	Temperature range, installation, max.	100 °C

Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	15 A
Rated current, max. number of poles (Tu=20°C)	12 A	Rated current, min. number of poles (Tu=40°C)	13 A
Rated current, max. number of poles (Tu=40°C)	10 A	Rated voltage for surge voltage class / pollution degree II/2	320 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	160 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 100 A

Technical data

SL-SMT 3.50/24/90G 3.2SN BK BX



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Institute (CSA)	SP:	Certificate No. (CSA)	
			200039-1176845
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	10 A	Rated current (Use group D / CSA)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		
Packing			
Packaging	Вох	VPE length	127 mm
VPE width	90 mm	VPE height	40 mm
Classifications			
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-02-01
Important note			
	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.		
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Technical data

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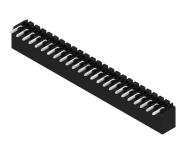
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Downloads	
Approval/Certificate/Document of	
Conformity	Declaration of the Manufacturer
Engineering Data	CAD data – STEP
Catalogues	Catalogues in PDF-format
Brochures	FL DRIVES EN
	MB SMT EN
	FL DRIVES DE
	MB DEVICE MANUF. EN
	FL BUILDING SAFETY EN
	FL APPL LED LIGHTING EN
	FL INDUSTR.CONTROLS EN
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	FL POWER SUPPLY EN
	FL 72H SAMPLE SER EN
	PO OMNIMATE EN
	PO OMNIMATE EN
White paper surface mount technology	Download Whitepaper

Drawings

Product image



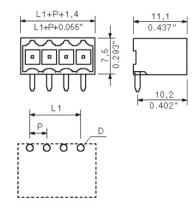


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Dimensional drawing



L1 = 80.50 mm | P = 3.50 mm

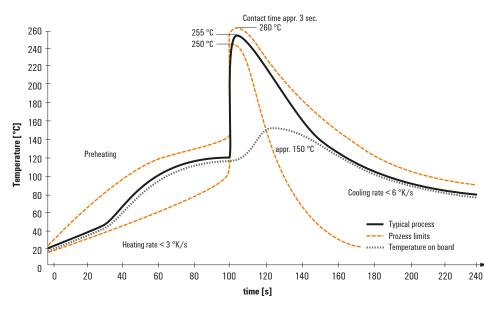
Wave Solder Profile

Recommended wave solderding profiles

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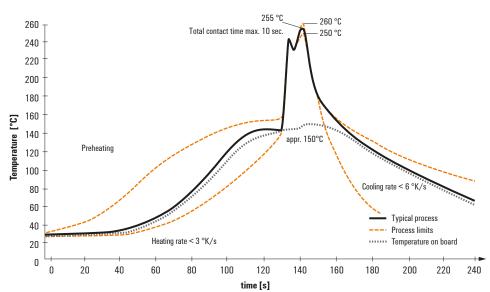
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Double Wave:

Single Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

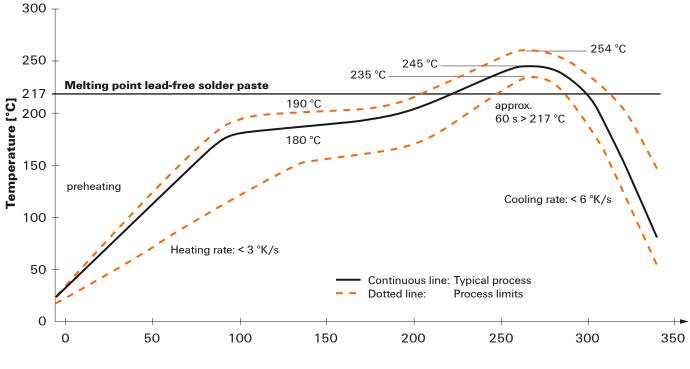
Reflow Solder Profile

Recommended reflow soldering profile



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Time [sec]

Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.